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			·			Application Number	10/642,335
	INFORMATION DISCLOSURE					Filing Date	August 15, 2003
STATEMENT BY APPLICANT					First Named Inventor	Edwin C. Bailey	
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(Use as equany sheets as necessary)						Examiner Name	
Sheet	1	86	0	f	1	Attorney Docket Number	14518.0012
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13		<u> </u>	U.S. PATENT DOO	CUMENTS		
Examiner	Cipe AI	Document Number	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines Where Relevant	
Initials*	No.	Number-Kind Code <sup>2</sup> (if known)			Passages or Relevant Figures Appear	
111	1	US-3,049,796	08/21/1962	Pail		
	2	US-3,395,528	08/06/1968	Lucht .		
	3	US-3,690,606	09/12/1972	Pall		
	4	US-3,895,162	07/15/1975	Lemont et al.		
1	5	US-4,514,458	04/30/1985	Thorn et al.		
	6	US-4,686,342	08/11/1987	Collier et al.	0	
	7	US-4,878,314	11/07/1989	Blockinger		
	8	US-5,205,877	04/27/1993	Collier et al.		
	9	US-5,423,838	06/13/1995	Willard		
	10	US-5,674,208	10/07/1997	Berg et al.		
1	11	US-6,106,639	08/22/2000	Marandel et al.		
7/	12	US-6,263,949	07/24/2001	Guthrie, Jr.		
	1	US-				
<i>*</i>		US-				
	1	US-				
		US-			1	
		US-				

			ATENT DOCUME	113		_
Examiner Initials*	Cite No. 1	Foreign Patent Document  Country Code <sup>3</sup> Number <sup>4</sup> Kind Code <sup>5</sup> (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines Where Relevant Passages or Relevant Figures Appear	T <sup>6</sup>
1	1	Japan	02/08/2000	Tokyo Process Service KK		
	2	Japan	11/05/1996	Kyokuto Kogen Concrete Shinko KK		
	3	Japan	02/22/1980 -and- 03/29/1986	TDK Electronics Co. Ltd.		
\	4	Japan	06/04/1987	Sony Corp.		
H	5	Japan	03/06/1991	Kobe Steel Ltd.		
7						

Examiner	1//	Date	VC
Signature	n//	Considered	2.4.05

<sup>•</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>&</sup>lt;sup>1</sup> Applicant's unique citation designation number (optional). <sup>2</sup> See Kinds Codes of USPTO Patent Documents at <a href="https://www.uspto.gov">www.uspto.gov</a> or MPEP 901.04. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>4</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>5</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>6</sup> Applicant is to place a check mark here if English language Translation is attached.